

N-channel SiC power MOSFET

Datasheet

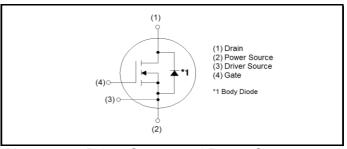
| V_{DSS} | 1200V |
|----------------------------|-------|
| R _{DS(on)} (Typ.) | 105mΩ |
| $I_{D}^{^{*1}}$ | 24A |
| P_{D} | 134W |

Outline TO-247-4L (1) (2)(3)(4)

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

•Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

Packaging specifications

| | Packing | Tube |
|------|---------------------------|-----------|
| | Reel size (mm) | - |
| Typo | Tape width (mm) | - |
| Type | Basic ordering unit (pcs) | 30 |
| | Taping code | C15 |
| | Marking | SCT3105KR |

◆Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified)

| Parameter | | Symbol | Value | Unit |
|--|------------------------|---------------------------|----------------------------|------|
| Drain - Source Voltage | | V_{DSS} | 1200 | V |
| Continuous Drain current | T _c = 25°C | I _D *1 | 24 | Α |
| Continuous Drain current | T _c = 100°C | I _D *1 | 17 | Α |
| Pulsed Drain current (T _c = 25°C) | | I _{D,pulse} *2 | I _{D,pulse} *2 60 | |
| Gate - Source voltage (DC) | | V_{GSS} | -4 to +22 | V |
| Gate - Source surge voltage (t _{surge} < 300ns) | | V _{GSS_surge} *3 | -4 to +26 | V |
| Recommended drive voltage | | V _{GS_op} *4 | 0 / +18 | V |
| Virtual Junction temperature | | T _{vj} | 175 | °C |
| Range of storage temperature | | T _{stg} | -55 to +175 | °C |

●Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

| Darameter | Symbol | Conditions | Values | | | Unit |
|---|------------------------|--------------------------------|--------|------|------|-------|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Offic |
| | | $V_{GS} = 0V$, $I_D = 1mA$ | | | | |
| Drain - Source breakdown voltage | V _{(BR)DSS} | $T_{vj} = 25^{\circ}C$ | 1200 | - | - | V |
| vollago | | T _{vj} = -55°C | 1200 | - | - | |
| | | $V_{GS} = 0V, V_{DS} = 1200V$ | | | | |
| Zero Gate voltage Drain current | I _{DSS} | $T_{vj} = 25^{\circ}C$ | - | 1 | 10 | μΑ |
| Diam current | | T _{vj} = 150°C | - | 2 | - | |
| Gate - Source leakage current | I _{GSS+} | $V_{GS} = +22V, \ V_{DS} = 0V$ | - | - | 100 | nA |
| Gate - Source leakage current | I _{GSS-} | $V_{GS} = -4V$, $V_{DS} = 0V$ | - | - | -100 | nA |
| Gate threshold voltage | V _{GS (th)} | $V_{DS} = 10V, I_D = 3.81mA$ | 2.7 | - | 5.6 | V |
| | | $V_{GS} = 18V, I_D = 7.6A$ | | | | |
| Static Drain - Source on - state resistance | R _{DS(on)} *5 | $T_{vj} = 25^{\circ}C$ | - | 105 | 137 | mΩ |
| on state resistance | | T _{vj} = 150°C | - | 179 | - | |
| Gate input resistance | R_{G} | f = 1MHz, open drain | - | 13 | - | Ω |

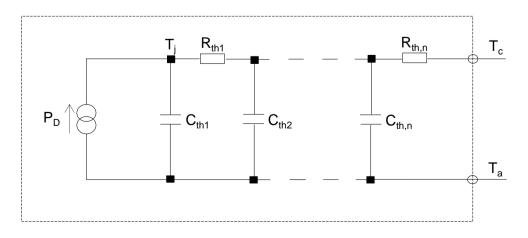
●Thermal resistance

| Parameter | Symbol | Values | | | Unit |
|-------------------------------------|------------|--------|------|------|-------|
| r arameter | | Min. | Тур. | Max. | Offic |
| Thermal resistance, junction - case | R_{thJC} | - | 0.86 | 1.12 | K/W |

●Typical Transient Thermal Characteristics

| Symbol | Value | Unit |
|------------------|-----------------------|------|
| R _{th1} | 1.14×10 ⁻¹ | |
| R _{th2} | 5.07×10 ⁻¹ | K/W |
| R _{th3} | 2.51×10 ⁻¹ | |

| Symbol | Value | Unit |
|------------------|-----------------------|------|
| C_{th1} | 5.02×10 ⁻⁴ | |
| C_{th2} | 4.91×10 ⁻³ | Ws/K |
| C _{th3} | 4.99×10 ⁻² | |



ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

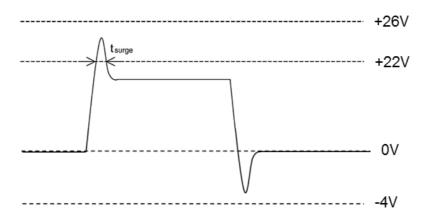
| Doromotor | Symbol Conditions | Values | | | Unit | |
|--|------------------------|---|------|------|------|------|
| Parameter | | Conditions | Min. | Тур. | Max. | Unit |
| Transconductance | g fs *5 | $V_{DS} = 10V, I_{D} = 7.6A$ | - | 3.4 | - | S |
| Input capacitance | C _{iss} | V _{GS} = 0V | - | 574 | - | |
| Output capacitance | C _{oss} | V _{DS} = 800V | - | 59 | ı | pF |
| Reverse transfer capacitance | C_{rss} | f = 1MHz | - | 28 | ı | |
| Effective output capacitance, energy related | C _{o(er)} | $V_{GS} = 0V$ $V_{DS} = 0V$ to 600V | ı | 159 | 1 | pF |
| Total Gate charge | Q _g *5 | $V_{DS} = 600V$ $I_{D} = 7.6A$ | - | 51 | ı | |
| Gate - Source charge | Q _{gs} *5 | $V_{GS} = 18V$ | - | 10 | - | nC |
| Gate - Drain charge | Q _{gd} *5 | See Fig. 1-1. | - | 25 | - | |
| Turn - on delay time | t _{d(on)} *5 | $V_{DS} = 600V$ | - | 4 | ı | |
| Rise time | t _r *5 | $I_D = 12A$ $V_{GS} = 0V/+18V$ | - | 12 | - | 20 |
| Turn - off delay time | t _{d(off)} *5 | $R_G = 0\Omega, L = 750\mu H$ $L_G = 50nH, C_G = 10pF$ | - | 15 | ı | ns |
| Fall time | t _f *5 | See Fig. 2-1, 2-2, 2-3. | - | 11 | - | |
| Turn - on switching loss | E _{on} *5 | E _{on} includes diode reverse recovery. | - | 134 | - | 11.1 |
| Turn - off switching loss | E _{off} *5 | | - | 10 | - | μJ |

●Body diode electrical characteristics (Source-Drain) (T_{vj} = 25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--|-----------------------|--|--------|------|------|-------|
| raiailletei | Symbol | Coriditions | Min. | Тур. | Max. | Offic |
| Body diode continuous, forward current | I _S *1 | T _c = 25°C | ı | 1 | 24 | А |
| Body diode direct current, pulsed | I _{SM} *2 | 1 _c – 25 0 | ı | ı | 60 | А |
| Forward voltage | V _{SD} *5 | $V_{GS} = 0V, I_{S} = 7.6A$ | ı | 3.2 | ı | V |
| Reverse recovery time | t _{rr} *5 | $I_F = 7.6A$ $V_R = 600V$ | ı | 13 | ı | ns |
| Reverse recovery charge | Q _{rr} *5 | di/dt = 2500A/µs | ı | 175 | ı | nC |
| Peak reverse recovery current | : I _{rrm} *5 | $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2. | - | 22 | - | А |

^{*1} Limited by maximum $T_{\nu j}$ and for Max. R_{thJC} .

^{*3} Example of acceptable V_{GS} waveform



Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

*5 Pulsed

^{*2} PW \leq 10 μ s, Duty cycle \leq 1%

^{*4} Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

Fig.1 Power Dissipation Derating Curve

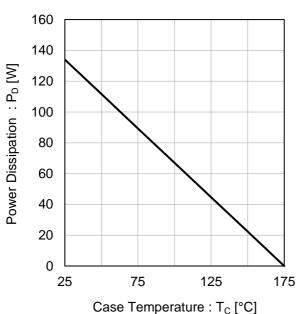


Fig.2 Maximum Safe Operating Area

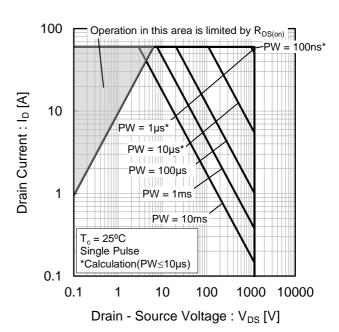
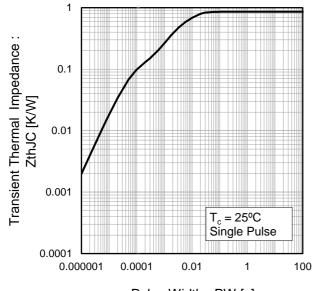


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width



Pulse Width : PW [s]

Fig.4 Typical Output Characteristics(I)

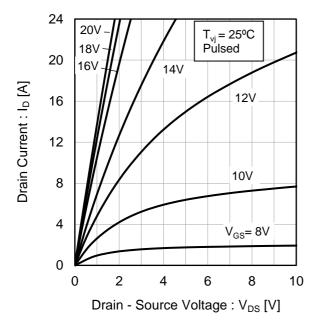


Fig.5 Typical Output Characteristics(II)

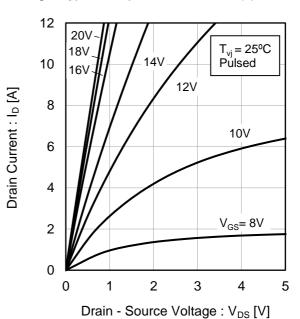
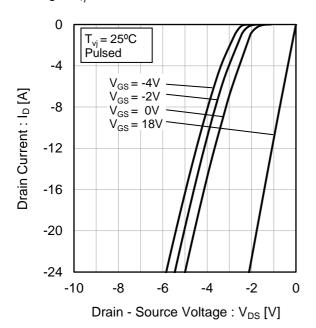
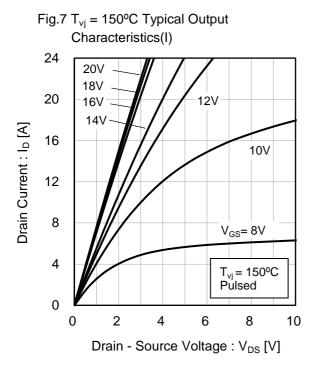


Fig.6 T_{vj} = 25°C 3rd Quadrant Characteristics





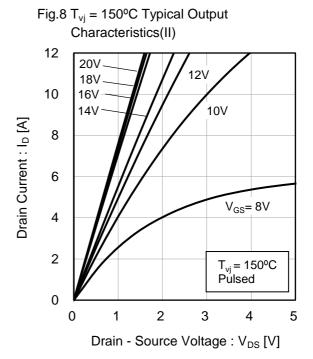


Fig.9 T_{vj} = 150°C 3rd Quadrant Characteristics 0 $T_{vj} = 150^{\circ}C$ Púlsed -4 $V_{GS} = -4V$ $V_{GS} = -2V$ $V_{GS} = 0V$ $V_{GS} = 18V$ Drain Current: Ip [A] -8 -12 -16 -20 -24 -10 -8 -6 -4 -2 0 Drain - Source Voltage: V_{DS} [V]

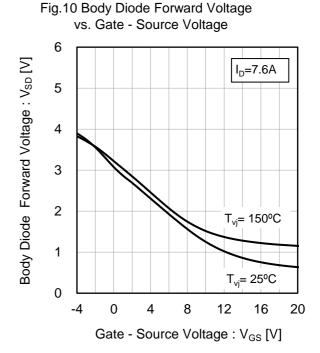


Fig.11 Typical Transfer Characteristics (I)

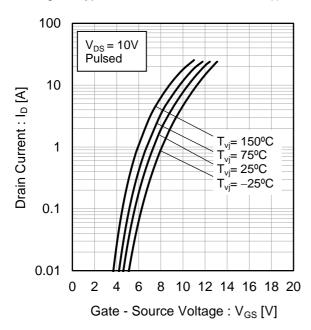


Fig.12 Typical Transfer Characteristics (II)

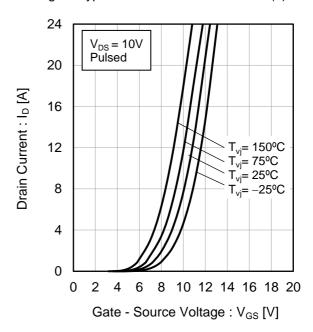


Fig.13 Gate Threshold Voltage vs. Virtual Junction Temperature

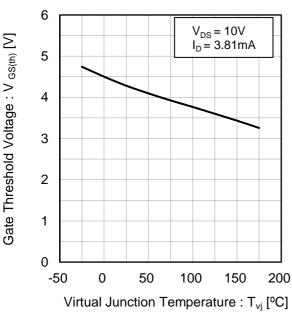
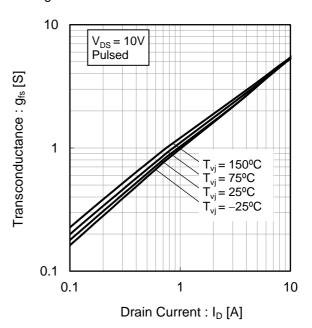
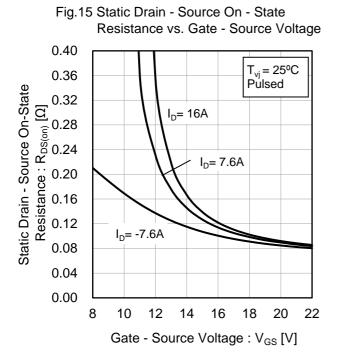


Fig.14 Transconductance vs. Drain Current





Resistance vs. Virtual Junction Temperature 0.30 $V_{GS} = 18V$ Pulsed Static Drain - Source On-State 0.24 $I_D = 16A$ I_D= 7.6A $I_{D} = -7.6A$ 0.06 0.00 -50 0 50 100 200 150

Virtual Junction Temperature : T_{vi} [°C]

Fig.16 Static Drain - Source On - State

Resistance vs. Drain Current

1

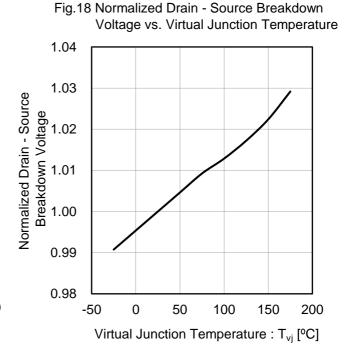
Output

Solution

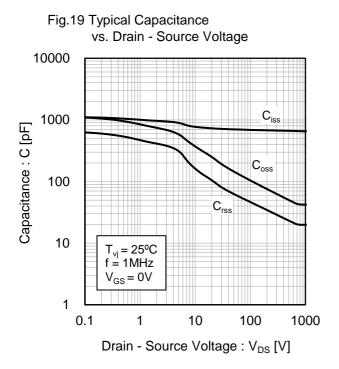
Output

Ou

Fig.17 Static Drain - Source On - State



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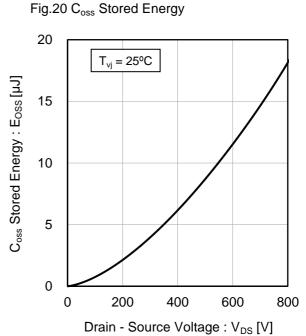
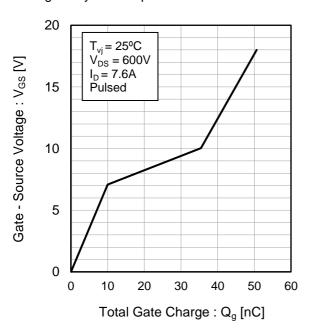


Fig.21 Dynamic Input Characteristics



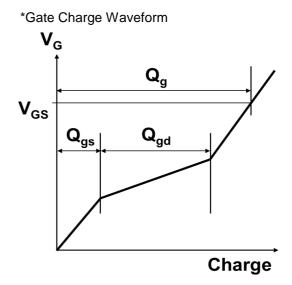


Fig.22 Typical Switching Time vs. External Gate Resistance

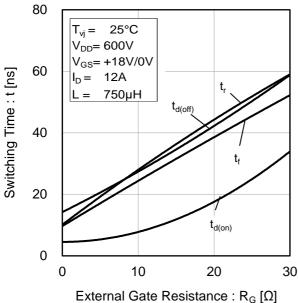


Fig.23 Typical Switching Loss vs. Drain - Source Voltage

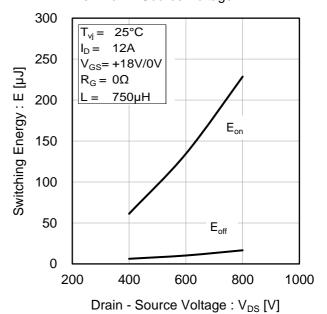


Fig.24 Typical Switching Loss vs. Drain Current

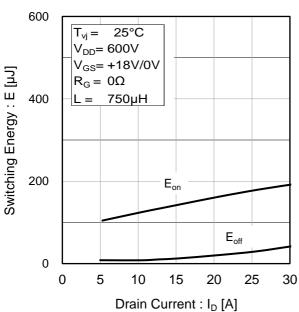
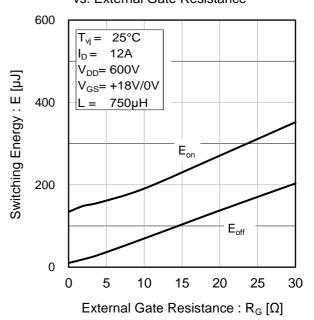


Fig.25 Typical Switching Loss vs. External Gate Resistance



Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

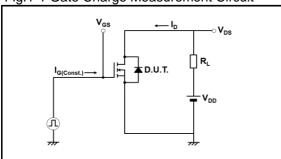


Fig.2-1 Switching Characteristics Measurement Circuit

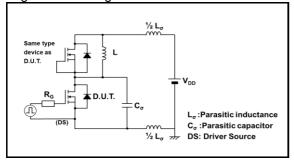


Fig.2-2 Waveforms for Switching Time

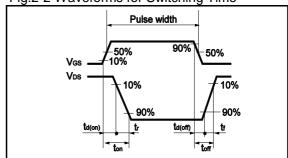


Fig.2-3 Waveforms for Switching Energy Loss

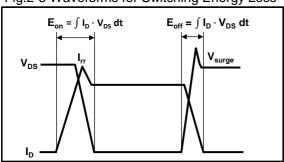


Fig.3-1 Reverse Recovery Time Measurement Circuit

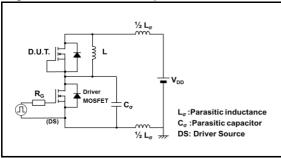
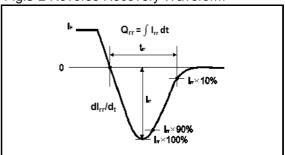
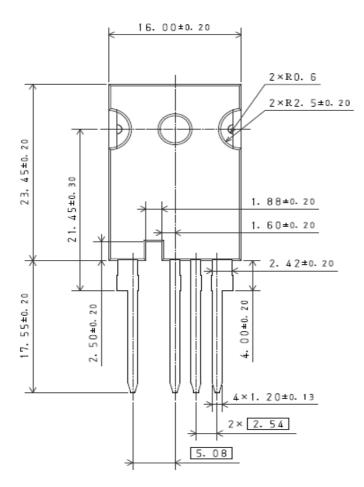
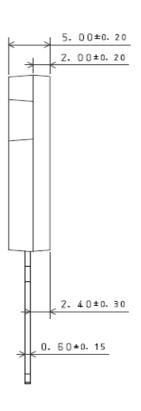


Fig.3-2 Reverse Recovery Waveform

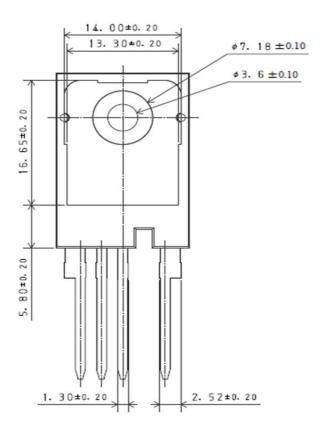


●Package Dimensions



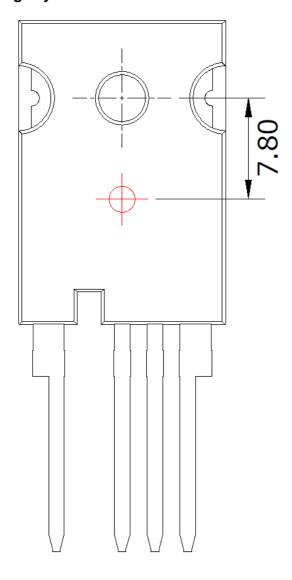


Unit: mm



Unit: mm

●Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- •If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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